

DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

☐ Original ☐ Supplemental ☐ Substitute ☒ PCT ☐ DESIGN

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Title: SUBSTRATE HOLDING MECHANISM, SUBSTRATE POLISHING APPARATUS AND SUBSTRATE POLISHING METHOD

of which is described and claimed in:

☐ the attached specification, or
☐ the specification in application Serial No. _____, filed _____, and with amendments through _____, or
☒ the specification in International Application No. PCT/JP2003/017032, filed December 26, 2003, and as amended on June 16, 2005 (if applicable).

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	2002-380583	December 27, 2002	YES
Japan	2003-188775	June 30, 2003	YES

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; Michael S. Huppert, Reg. No. 40,268; and Jeffrey R. Filipek, Reg. No. 41,471, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office

ATTACHMENT B

connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from YUASA & HARA as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Direct Correspondence to:		Direct Telephone Calls to:	
CUSTOMER NO. 000513		WENDEROTH, LIND & PONACK, L.L.P. 2033 "K" Street, N.W., Suite 800 Washington, D.C. 20006-1021 Phone:(202) 721-8200 Fax:(202) 721-8250	
Full Name of First Inventor	FAMILY NAME TOGAWA	FIRST GIVEN NAME Tetsuji	SECOND GIVEN NAME
Residence & Citizenship	CITY Chigasaki-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 3-1-46, Shorin, Chigasaki-shi, Kanagawa	CITY	STATE OR COUNTRY 253-0017 Japan
Full Name of Second Inventor	FAMILY NAME WATANABE	FIRST GIVEN NAME Toshio	SECOND GIVEN NAME
Residence & Citizenship	CITY Tokyo	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 3-28-8, Shibamata, Katsushika-ku, Tokyo	CITY	STATE OR COUNTRY 125-0052 Japan
Full Name of Third Inventor	FAMILY NAME YANO	FIRST GIVEN NAME Hiroyuki	SECOND GIVEN NAME
Residence & Citizenship	CITY Yokohama-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 5-21-24, Nara, Aoba-ku, Yokohama-shi, Kanagawa	CITY	STATE OR COUNTRY 227-0038 Japan
Full Name of Fourth Inventor	FAMILY NAME TOYOTA	FIRST GIVEN NAME Gen	SECOND GIVEN NAME
Residence & Citizenship	CITY Yokohama-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 2-39-1-305, Hatsune-cho, Naka-ku, Yokohama-shi, Kanagawa	CITY	STATE OR COUNTRY 231-0053 Japan
Full Name of Fifth Inventor	FAMILY NAME IWADE	FIRST GIVEN NAME Kenji	SECOND GIVEN NAME
Residence & Citizenship	CITY Hiratsuka-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan

Post Office Address	ADDRESS 4-7-203, Nishiki-cho, Hiratsuka-shi, Kanagawa 254-0044 Japan	CITY	STATE OR COUNTRY	ZIP CODE
Full Name of Sixth Inventor	FAMILY NAME TATEYAMA	FIRST GIVEN NAME Yoshikuni	SECOND GIVEN NAME	
Residence & Citizenship	CITY Oita-shi	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan	
Post Office Address	ADDRESS 2-8-23, Yokota, Oita-shi, Oita 870-0263 Japan	CITY	STATE OR COUNTRY	ZIP CODE

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor _____ Date _____
Tetsuji TOGAWA

2nd Inventor _____ Date _____
Toshio WATANABE

3rd Inventor _____ Date _____
Hiroyuki YANO

4th Inventor _____ Date _____
Gen TOYOTA

5th Inventor _____ Date _____
Kenji IWADA

6th Inventor _____ Date _____
Yoshikuni TATEYAMA

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date June 16, 2005

Applicant Reference Number ME:FK, PC/E(X)-6-844US Atty Docket No. 2005-0993A

Title of Invention SUBSTRATE HOLDING MECHANISM, SUBSTRATE POLISHING APPARATUS AND SUBSTRATE POLISHING METHOD